Low Voltage Quad 2-Input Multiplexer



74LCX157

The LCX157 is a high-speed quad 2-input multiplexer. Four bits of data from two sources can be selected using the common Select and Enable inputs. The four outputs present the selected data in the true (non-inverted) form.

The LCX157 can also be used as a function generator.

The 74LCX157 is fabricated with advanced CMOS technology to achieve high speed operation while maintaining CMOS low power dissipation.

Features

- 5 V Tolerant Inputs
- 1.65 V to 5.5 V, V_{CC} Specifications Provided
- 5.8 ns t_{PD} Max. (V_{CC} = 3.3 V), 10 μ A I_{CC} Max.
- Power Down High Impedance Inputs and Outputs
- ± 24 mA Output Drive (V_{CC} = 3.0 V)
- Implements Patented Noise/EMI Reduction Circuitry
- Latch-up Performance Exceeds 100 mA
- ESD Performance: Human Body Model >2000 V
- These are Pb-Free Devices

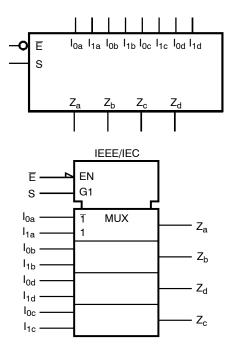
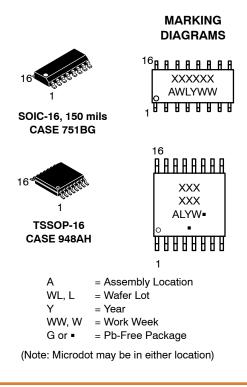


Figure 1. Logic Symbols



ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 7 of this data sheet.

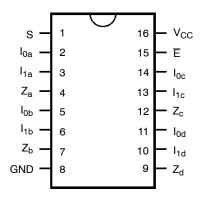


Figure 2. Connection Diagram

Functional Description

The LCX157 is a quad 2-input multiplexer. It selects four bits of data from two sources under the control of a common Select input (S). The Enable input (\overline{E}) is active-LOW. When \overline{E} is HIGH, all of the outputs (Z) are forced LOW regardless of all other inputs. The LCX157 is the logic implementation of a 4-pole, 2-position switch where the position of the switch is determined by the logic levels supplied to the Select input. The logic equations for the outputs are shown below:

 $\begin{aligned} &Za = \overline{E} \bullet (I_{1a} \bullet S + I_{0a} \bullet \overline{S}) \\ &Zb = \overline{E} \bullet (I_{1b} \bullet S + I_{0b} \bullet \overline{S}) \\ &Zc = \overline{E} \bullet (I_{1c} \bullet S + I_{0c} \bullet \overline{S}) \\ &Zd = \overline{E} \bullet (I_{1d} \bullet S + I_{0d} \bullet \overline{S}) \end{aligned}$

A common use of the LCX157 is the moving of data from two groups of registers to four common output busses. The particular register from which the data comes is determined

PIN DESCRIPTIONS

Pin Names	Description
I _{0a} -I _{0d}	Source 0 Data Inputs
$I_{1a} - I_{1d}$	Source 1 Data Inputs
Ē	Enable Input
S	Select Inputs
Z _a -Z _d	Outputs

by the state of the Select input. A less obvious use is as a function generator. The LCX157 can generate any four of the sixteen different functions of two variables with one variable common. This is useful for implementing gating functions.

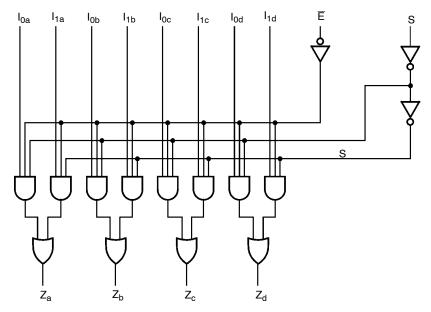
TRUTH TABLE

	Outputs			
Ē	S	I ₀	I ₁	Z
Н	Х	Х	Х	L
L	н	х	L	L
L	Н	Х	Н	Н
L	L	L	Х	L
L	L	н	Х	н

H = HIGH Voltage Level

L = LOW Voltage Level

X = Immaterial



NOTE: Please note that this diagram is provided only for the understanding of logic operations and should not be used to estimate propagation delays.

Figure 3. Logic Diagram

ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter		Value	Unit
V _{CC}	DC Supply Voltage		-0.5 to +6.5	V
VI	DC Input Voltage (Note 1)		-0.5 to +6.5	V
V _O		Mode (High or Low State) Tri-State Mode r-Down Mode (V _{CC} = 0 V)	$\begin{array}{c} -0.5 \text{ to } V_{CC} + 0.5 \\ -0.5 \text{ to } +6.5 \\ -0.5 \text{ to } +6.5 \end{array}$	V
I _{IK}	DC Input Diode Current	V _I < GND	-50	mA
I _{OK}	DC Output Diode Current	V _O < GND	-50	mA
Ι _Ο	DC Output Source/Sink Current		±50	mA
$I_{\rm CC}$ or $I_{\rm GND}$	DC Supply Current per Supply Pin or Ground Pin		±100	mA
T _{STG}	Storage Temperature Range		-65 to +150	°C
ΤL	Lead Temperature, 1 mm from Case for 10 secs		260	°C
TJ	Junction Temperature Under Bias		+150	°C
θ_{JA}	Thermal Resistance (Note 1)	SOIC-16 TSSOP-16	126 159	°C/W
PD	Power Dissipation in Still Air at 125°C	SOIC-16 TSSOP-16	995 787	mW
MSL	Moisture Sensitivity		Level 1	-
F _R	Flammability Rating	Oxygen Index: 28 to 34	UL 94 V-0 @ 0.125 in	-
V _{ESD}	ESD Withstand Voltage (Note 3)	Human Body Model Charged Device Model	2000 N/A	V

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected. 1. I_O absolute maximum rating must be observed.

 Measured with minimum pad spacing on an FR4 board, using 76 mm-by-114 mm, 2-ounce copper trace no air flow per JESD51-7.
 HBM tested to EIA / JESD22-A114-A. CDM tested to JESD22-C101-A. JEDEC recommends that ESD qualification to EIA/JESD22-A115A (Machine Model) be discontinued.

RECOMMENDED OPERATING CONDITIONS

Symbol	Pa	arameter	Min	Тур	Max	Unit
V _{CC}	Supply Voltage	Operating Data Retention Only	1.65 1.5	3.3 3.3	5.5 5.5	V
VI	Digital Input Voltage		0	-	5.5	V
Vo	Output Voltage	Active Mode (High or Low State) Tri-State Mode Power Down Mode (V _{CC} = 0 V)	0 0 0	- - -	V _{CC} 5.5 5.5	V
T _A	Operating Free-Air Temperature		-40	-	+125	°C
t _r , t _f	Input Rise or Fall Rate	$\label{eq:V_CC} \begin{array}{l} V_{CC} = 1.65 \mbox{ V to } 1.95 \mbox{ V} \\ V_{CC} = 2.3 \mbox{ V to } 2.7 \mbox{ V} \\ V_{IN} \mbox{ from } 0.8 \mbox{ V to } 2.0 \mbox{ V}, \mbox{ V}_{CC} = 3.0 \mbox{ V} \\ V_{CC} = 4.5 \mbox{ V to } 5.5 \mbox{ V} \end{array}$	0 0 0	- - - -	20 20 10 5	nS/V

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

4. Unused inputs must always be tied to an appropriate logic voltage level (e.g., either GND or V_{CC}). Unused outputs must be left open.

DC ELECTRICAL CHARACTERISTICS

				T _A = -40°0	C to +85°C	T _A = -40°C	to +125°C	
Symbol	Parameter	Conditions	V _{CC} (V)	Min	Max	Min	Мах	Unit
VIH	HIGH Level Input Voltage		1.65 – 1.95	$0.65 \times V_{CC}$	-	$0.65 \times V_{CC}$	-	V
			2.3 – 2.7	1.7	_	1.7	-	
			3.0 - 3.6	2.0	_	2.0	-	
			4.5 – 5.5	$0.70 \times V_{CC}$	-	$0.70 \times V_{CC}$	-	
V _{IL}	LOW Level Input Voltage		1.65 – 1.95	-	$0.35 \times V_{CC}$	-	$0.35 \times V_{CC}$	V
			2.3 – 2.7	-	0.7	-	0.7	
			3.0 - 3.6	-	0.8	-	0.8	
			4.5 – 5.5	-	$0.30 \times V_{CC}$	-	$0.30 \times V_{CC}$	
V _{OH}	High-Level Output Voltage		1.65 - 5.5 1.65 2.3 2.7 3.0 3.0 4.5	V _{CC} - 0.1 1.29 1.8 2.2 2.4 2.2 3.7	- - - - -	V _{CC} - 0.1 1.29 1.8 2.2 2.4 2.2 3.7		V
V _{OL}	Low-Level Output Voltage	$V_{I} = V_{IH} \text{ or } V_{IL}$ $I_{OL} = 100 \ \mu\text{A}$ $I_{OL} = 4 \ \text{mA}$ $I_{OL} = 8 \ \text{mA}$ $I_{OL} = 12 \ \text{mA}$ $I_{OL} = 16 \ \text{mA}$ $I_{OL} = 24 \ \text{mA}$ $I_{OL} = 32 \ \text{mA}$	1.65 - 5.5 1.65 2.3 2.7 3.0 3.0 4.5	- - - - -	0.1 0.24 0.3 0.4 0.4 0.55 0.6		0.1 0.24 0.3 0.4 0.4 0.55 0.6	V
l	Input Leakage Current	V _I = 0 to 5.5 V	1.65 – 5.5	_	±5.0	-	±5.0	μA
I _{OFF}	Power Off Leakage Current	$V_{I} = 5.5 V \text{ or}$ $V_{O} = 5.5 V$	0	-	10	-	10	μA
I _{CC}	Quiescent Supply Current	V_{I} = 5.5 V or GND	1.65 – 5.5	-	10	-	10	μA
ΔI_{CC}	Increase in I _{CC} per Input	$V_{IH} = V_{CC} - 0.6 V$	2.3 – 3.6	-	500	-	500	μA

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

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AC ELECTRICAL CHARACTERISTICS

				T _A = −40°C to +85°C		T _A = -40°C		
Symbol	Parameter	Test Condition	V _{CC} (V)	Min	Max	Min	Max	Unit
t _{PLH} , t _{PHL}	Propagation Delay,	See Figures 4 and 5	1.65 to 1.95	-	11.6	-	11.6	ns
	S to Z _n		2.3 to 2.7	-	8.4	-	8.4	
			2.7	-	8.0	-	8.0	
			3.0 to 3.6	-	7.0	-	7.0	
			4.5 to 5.5	-	5.8	-	5.8	
t _{PLH} , t _{PHL}	Propagation Delay,	See Figures 4 and 5	1.65 to 1.95	-	11.6	-	11.6	ns
	E to Z _n		2.3 to 2.7	-	8.4	-	8.4	
			2.7	-	8.0	-	8.0	
			3.0 to 3.6	-	7.0	-	7.0	
			4.5 to 5.5	-	5.8	-	5.8	
t _{PLH} , t _{PHL}	Propagation Delay,	See Figures 4 and 5	1.65 to 1.95	-	11.2	-	11.2	ns
	I _n to Z _n		2.3 to 2.7	-	7.0	-	7.0	
			2.7	-	6.3	-	6.3	
			3.0 to 3.6	-	5.8	-	5.8	
			4.5 to 5.5	-	4.8	-	4.8	
t _{OSHL} ,	Output to Output Skew		1.65 to 1.95	-	-	-	-	ns
t _{OSLH}	(Note 5)		2.3 to 2.7	-	-	-	-	
			2.7	-	-	-	-	
			3.0 to 3.6	-	1.0	-	1.0	
			4.5 to 5.5	-	-	-	-	

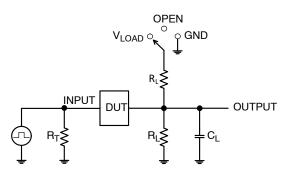
Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.
5. Skew is defined as the absolute value of the difference between the actual propagation delay for any two separate outputs of the same device. The specification applies to any outputs switching in the same direction, either HIGH-to-LOW (t_{OSHL}) or LOW-to-HIGH (t_{OSLH}).

DYNAMIC SWITCHING CHARACTERISTICS

				T _A = 25°C	
Symbol	Parameter	Conditions	V _{CC} (V)	Typical	Unit
V _{OLP}	Quiet Output Dynamic Peak V _{OL}	C_L = 50 pF, V_{IH} = 3.3 V, V_{IL} = 0 V	3.3	0.8	V
		$C_L = 30 \text{ pF}, \text{ V}_{IH} = 2.5 \text{ V}, \text{ V}_{IL} = 0 \text{ V}$	2.5	0.6	
V _{OLV}	Quiet Output Dynamic Valley V_{OL}	$C_{L} = 50 \text{ pF}, \text{ V}_{IH} = 3.3 \text{ V}, \text{ V}_{IL} = 0 \text{ V}$	3.3	-0.8	V
		C_L = 30 pF, V_{IH} = 2.5 V, V_{IL} = 0 V	2.5	-0.6	

CAPACITANCE

Symbol	Parameter	Condition	Typical	Units
C _{IN}	Input Capacitance	V_{CC} = Open, V_I = 0 V or V_{CC}	7	pF
C _{OUT}	Output Capacitance	V_{CC} = 3.3 V, V_{I} = 0 V or V_{CC}	8	pF
C _{PD}	Power Dissipation Capacitance	V_{CC} = 3.3 V, V_{I} = 0 V or V_{CC},f = 10 MHz	25	pF



V....

Test	Switch Position
t _{PLH} / t _{PHL}	Open
t _{PLZ} / t _{PZL}	V _{LOAD}
t _{PHZ} / t _{PZH}	GND

 C_L includes probe and jig capacitance R_T is Z_{OUT} of pulse generator (typically 50 $\Omega)$ f = 1 MHz

10%

tрн

 t_{PLH}

t_r = 2.5 ns

INPUT

OUTPUT

OUTPUT

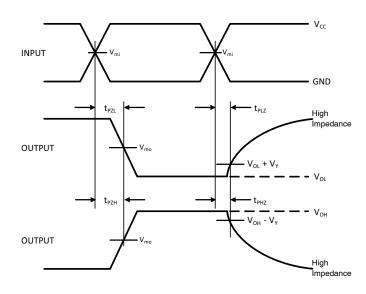


Figure	4	Test	Circuit

t_f = 2.5 ns

10%

۷.

V_{ma}

t_{PLH}

 t_{PHL} Þ

Vcc

GND

V_{OH}

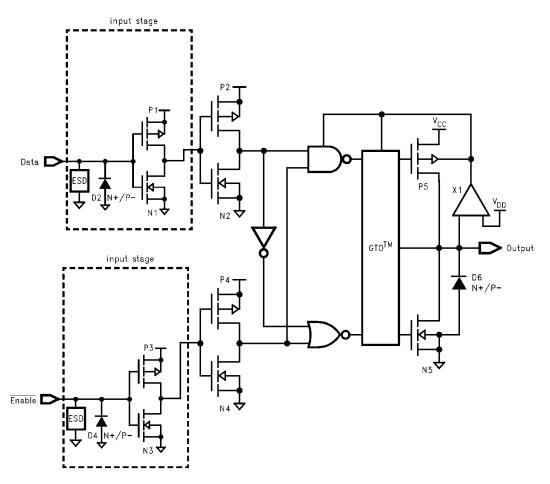
Vo

V_{OH}

 V_{OL}

V _{CC} , V	R_L, Ω	C _L , pF	V _{LOAD}	V _m , V	V _Y , V
1.65 to 1.95	500	30	$2 \times V_{CC}$	V _{CC} /2	0.15
2.3 to 2.7	500	30	$2 \times V_{CC}$	V _{CC} /2	0.15
2.7	500	50	6 V	1.5	0.3
3.0 to 3.6	500	50	6 V	1.5	0.3
4.5 to 5.5	500	50	$2 \times V_{CC}$	V _{CC} /2	0.3

Figure 5. Switching Waveforms





ORDERING INFORMATION

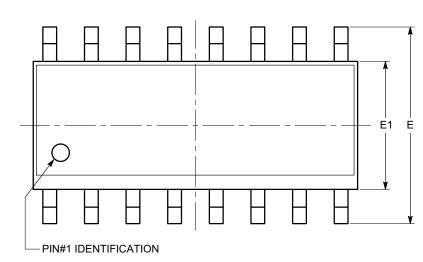
Device	Marking	Package	Shipping [†]
74LCX157MX	LCX157G	SOIC-16 (Pb-Free)	2500 Units / Tape & Reel
74LCX157MTCX	LCX 157	TSSOP-16 (Pb-Free)	2500 Units / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, <u>BRD8011/D</u>.



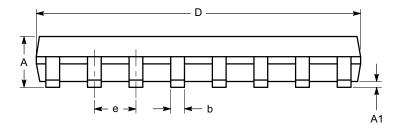
SOIC-16, 150 mils CASE 751BG ISSUE O

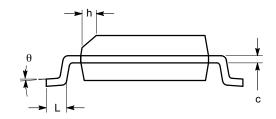
DATE 19 DEC 2008



SYMBOL	MIN	NOM	MAX
А	1.35		1.75
A1	0.10		0.25
b	0.33		0.51
с	0.19		0.25
D	9.80	9.90	10.00
E	5.80	6.00	6.20
E1	3.80	3.90	4.00
е		1.27 BSC	
h	0.25		0.50
L	0.40		1.27
θ	0°		8°

TOP VIEW





END VIEW

SIDE VIEW

Notes:

(1) All dimensions are in millimeters. Angles in degrees.

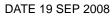
(2) Complies with JEDEC MS-012.

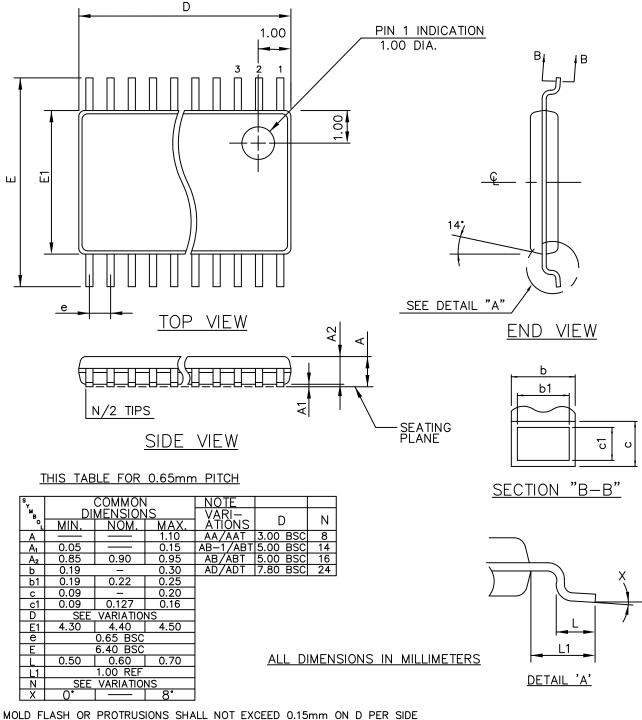
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